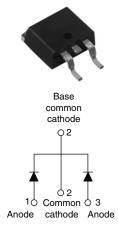
Vishay High Power Products

HEXFRED[®] Ultrafast Soft Recovery Diode, 2 x 8 A



D²PAK

PRODUCT SUMMARY				
V _R	600 V			
V _F at 8 A at 25 °C	1.7 V			
I _{F(AV)}	2 x 8 A			
t _{rr} (typical)	18 ns			
T _J (maximum)	150 °C			
Q _{rr}	65 nC			
dl _{(rec)M} /dt	240 A/μs			

FEATURES

- Ultrafast recovery
- Ultrasoft recovery
- Very low I_{RRM}
- Very low Q_{rr}
- Specified at operating conditions
- Designed and qualified for industrial level

BENEFITS

- Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- · Reduced parts count

DESCRIPTION

HFA16TA60CS is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 8 A per leg continuous current, the HFA16TA60CS is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{BBM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA16TA60CS is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V _R		600	V	
Maximum continuous forward current	- IF	T _C = 100 °C	8		
per device			16	Α	
Single pulse forward current	I _{FSM}		60	A	
Maximum repetitive forward current	I _{FRM}		24		
Maximum power dissipation	P _D	T _C = 25 °C	36	w	
Maximum power dissipation		T _C = 100 °C	14	vv	
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C	

HFA16TA60CS



Vishay High Power Products

HEXFRED[®] Ultrafast Soft Recovery Diode, 2 x 8 A

ELECTRICAL SPECIFICATIONS PER LEG ($T_J = 25 \text{ °C}$ unless otherwise specified)						_	
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	I _R = 100 μA		600	-	-	
	I _F = 8.0 A			-	1.4	1.7	v
Maximum forward voltage V	V _{FM}	I _F = 16 A	See fig. 1	-	1.7	2.1	
		I _F = 8.0 A, T _J = 125 °C		-	1.4	1.7	
Maximum reverse	1	$V_{R} = V_{R}$ rated	See fig. 2	-	0.3	5.0	μΑ
leakage current	IRM	T_J = 125 °C, V_R = 0.8 x V_R rated	See fig. 2	-	100	500	
Junction capacitance	CT	V _R = 200 V	See fig. 3	-	10	25	pF
Series inductance	L _S	Measured lead to lead 5 mm from package body		-	8.0	-	nH

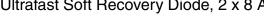
DYNAMIC RECOVERY CHARACTERISTICS PER LEG (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
.	t _{rr}	$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	18	-	
Reverse recovery time See fig. 5, 6 and 16	t _{rr1}	T _J = 25 °C	I _F = 8.0 A	-	37	55	ns
	t _{rr2}	T _J = 125 °C		-	55	90	
Peak recovery current	I _{RRM1}	T _J = 25 °C		-	3.5	5.0	A
See fig. 7 and 8	I _{RRM2}	T _J = 125 °C		-	4.5	8.0	
Reverse recovery charge	Q _{rr1}	T _J = 25 °C	dI _F /dt = 200 A/μs V _R = 200 V	-	65	138	nC
See fig. 9 and 10	Q _{rr2}	T _J = 125 °C		-	124	360	nC
Peak rate of fall of recovery current during t_b See fig. 11 & 12	dl _{(rec)M} /dt1	T _J = 25 °C		-	240	-	A/μs
	dl _{(rec)M} /dt2	T _J = 125 °C		-	210	-	πµs

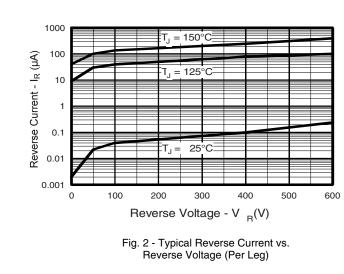
THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C
Junction to case, single leg conducting	P		-	-	3.5	
Junction to case, both legs conducting	R _{thJC}		-	-	1.75	K/W
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	80	
Weight			-	2	-	g
weight			-	0.07	-	oz.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf ⋅ cm (lbf ⋅ in)
Marking device		Case style D ² PAK		HFA16	FA60CS	

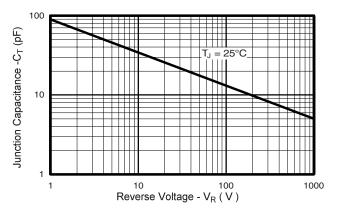


HEXFRED[®] Ultrafast Soft Recovery Diode, 2 x 8 A

Vishay High Power Products







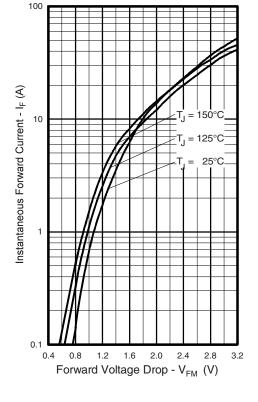


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current (Per Leg)

Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

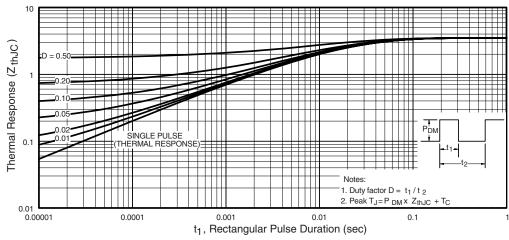


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

HFA16TA60CS

Vishay High Power Products

HEXFRED[®] Ultrafast Soft Recovery Diode, 2 x 8 A

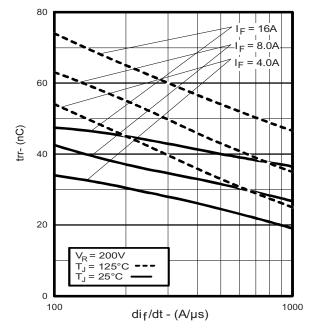
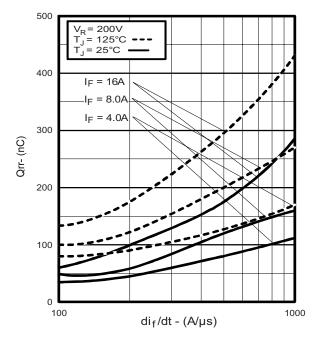
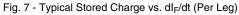


Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt (Per Leg)



VISHAY



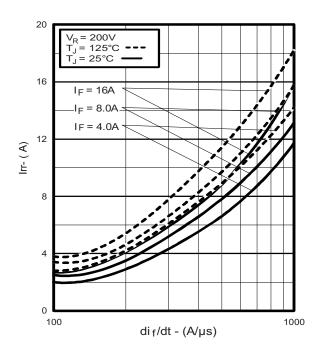


Fig. 6 - Typical Recovery Current vs. dl_F/dt (Per Leg)

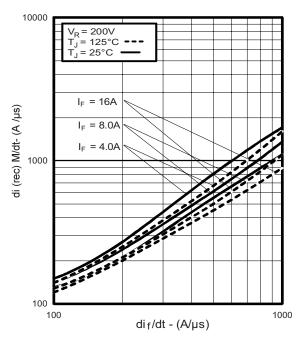


Fig. 8 - Typical dl_{(rec)M}/dt vs. dl_F/dt (Per Leg)



HEXFRED[®] Vishay High Power Products Ultrafast Soft Recovery Diode, 2 x 8 A

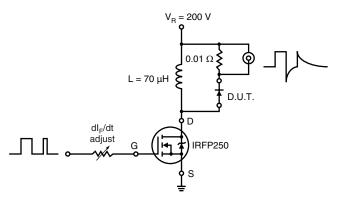


Fig. 9 - Reverse Recovery Parameter Test Circuit

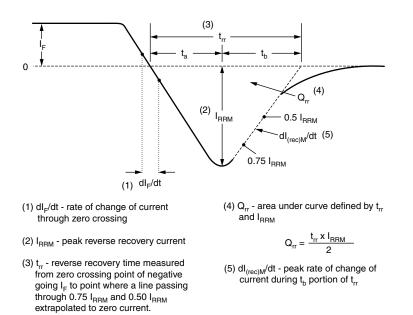


Fig. 10 - Reverse Recovery Waveform and Definitions

LINKS TO RELATED DOCUMENTS				
Dimensions http://www.vishay.com/doc?95046				
Part marking information http://www.vishay.com/doc?95054				
Packaging information	http://www.vishay.com/doc?95032			



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.